General Purpose Transistors

PNP Silicon

Features

- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)



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Rating	Symbol	Value	Unit			
Collector-Emitter Voltage BC856, SBC856 BC857, SBC857 BC858, NSVBC858, BC859	V _{CEO}	-65 -45 -30	V			
Collector-Base Voltage BC856, SBC856 BC857, SBC857 BC858, NSVBC858, BC859	V _{CBO}	-80 -50 -30	V			
Emitter-Base Voltage	V _{EBO}	-5.0	V			
Collector Current – Continuous	Ι _C	-100	mAdc			
Collector Current – Peak	Ι _C	-200	mAdc			

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C Derate above 25°C	PD	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	P _D	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. $FR-5 = 1.0 \times 0.75 \times 0.062$ in.

2. Alumina = 0.4 x 0.3 x 0.024 in 99.5% alumina.



SOT-23 (TO-236AB) **CASE 318 STYLE 6**

MARKING DIAGRAM



= Pb-Free Package

M

(Note: Microdot may be in either location) *Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown VoltageBC856, SBC856 Series(I _C = -10 mA)BC857, SBC857 SeriesBC858, NSBVC858 BC859 Series	V _{(BR)CEO}	-65 -45 -30	- - -	- - -	V
$\begin{array}{ll} \mbox{Collector-Emitter Breakdown Voltage} & BC856 \ S, \ SBC856eries \\ (I_C = -10 \ \mu A, \ V_{EB} = 0) & BC857A, \ SBC857A, \ BC857B, \ SBC857B \ Only \\ & BC858, \ NSVB858, \ BC859 \ Series \end{array}$	V _(BR) CES	80 50 30	- - -	- - -	V
	V _(BR) CBO	80 50 30	- - -	- - -	V
Emitter – Base Breakdown Voltage (I _E = –1.0 μA) BC856, SBC856 Series BC857, SBC857 Series BC858, NSVBC858, BC859 Series	V _{(BR)EBO}	-5.0 -5.0 -5.0	_ _ _	- - -	V
Collector Cutoff Current (V _{CB} = -30 V) (V _{CB} = -30 V, T _A = 150° C)	I _{CBO}	_ _	_ _	-15 -4.0	nA μA
ON CHARACTERISTICS					
$\begin{array}{llllllllllllllllllllllllllllllllllll$	h _{FE}		90 150		_
BC857C, SBC857C BC858C		-	270	-	
(I _C = -2.0 mA, V _{CE} = -5.0 V) BC856A, SBC856A, BC857A, SBC857A, BC858A		125	180	250	
BC856B, SBC856B, BC857B, SBC857B, BC858B, NSVBC858B, BC859B BC857C, SBC857C, BC858C, BC859C		220 420	290 520	475 800	
Collector – Emitter Saturation Voltage $(I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA})$ $(I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA})$	V _{CE(sat)}			-0.3 -0.65	V
Base – Emitter Saturation Voltage $(I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA})$ $(I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA})$	V _{BE(sat)}		-0.7 -0.9		V
Base – Emitter On Voltage $(I_C = -2.0 \text{ mA}, V_{CE} = -5.0 \text{ V})$ $(I_C = -10 \text{ mA}, V_{CE} = -5.0 \text{ V})$	V _{BE(on)}	-0.6 -		-0.75 -0.82	V
SMALL-SIGNAL CHARACTERISTICS					
Current-Gain – Bandwidth Product ($I_C = -10$ mA, $V_{CE} = -5.0$ Vdc, f = 100 MHz)	f _T	100	_	_	MHz
Output Capacitance (V _{CB} = -10 V, f = 1.0 MHz)	C _{ob}	_	_	4.5	pF
Noise Figure $(I_C = -0.2 \text{ mA}, V_{CE} = -5.0 \text{ Vdc}, R_S = 2.0 \text{ k}\Omega, f = 1.0 \text{ kHz}, BW = 200 \text{ Hz})$ BC856, SBC856, BC857, SBC857, BC858, NSVBC858 Series BC859 Series	NF			10 4.0	dB

BC857/BC858/BC859/SBC857/NSVBC858



BC856/SBC856





Figure 13. Thermal Response



Figure 14. Active Region Safe Operating Area

The safe operating area curves indicate I_C-V_{CE} limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 14 is based upon $T_{J(pk)} = 150^{\circ}C$; T_C or T_A is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 13. At high case or ambient temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by the secondary breakdown.

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]	
BC856ALT1G		SOT-23		
SBC856ALT1G*	3A	(Pb-Free)	3,000 / Tape & Reel	
BC856ALT3G			10,000 / Tape & Reel	
BC856BLT1G	SOT-23			
SBC856BLT1G*		(Pb-Free)	3,000 / Tape & Reel	
BC856BLT3G			10,000 / Tape & Reel	
SBC856BLT3G*				
BC857ALT1G		SOT-23		
SBC857ALT1G*	3E	(Pb-Free)	3,000 / Tape & Reel	
BC857BLT1G		SOT-23		
SBC857BLT1G*		(Pb-Free)	3,000 / Tape & Reel	
BC857BLT3G				
NSVBC857BLT3G*			10,000 / Tape & Reel	
BC857CLT1G		SOT-23		
SBC857CLT1G*	3G (Pb–Free)	(Pb-Free)	3,000 / Tape & Reel	
BC857CLT3G			10,000 / Tape & Reel	
BC858ALT1G	ЗJ	SOT-23 (Pb-Free)		
BC858BLT1G	214	SOT-23	3,000 / Tape & Reel	
NSVBC858BLT1G*	ЗК	(Pb-Free)		
BC858BLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel	
BC858CLT1G	3L	SOT-23 (Pb-Free)	3,000 / Tape & Reel	
BC858CLT3G		SOT-23 (Pb-Free)	10,000 / Tape & Reel	
BC859BLT1G		SOT–23 (Pb–Free)	3,000 / Tape & Reel	
BC859BLT3G		SOT–23 (Pb–Free)	10,000 / Tape & Reel	
BC859CLT1G	_	SOT–23 (Pb–Free)	3,000 / Tape & Reel	
BC859CLT3G	4C	SOT-23 (Pb-Free)	10,000 / Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AP**





- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3.
- DIMENSIONING AND TOLERANCULERANCING PER ANSI 114.30M, 156 CONTROLLING DIMENSION: INCH. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, DEPOTDUCING ON CATE PUPPE

^{4.} PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104
θ	0°		10°	0°		10°

STYLE 6: PIN 1. BASE EMITTER COLLECTOR 2. 3.

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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